

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor and is officers, employees, uniotificated use, even if such claim any manner.



FDMD8260L Dual N-Channel Power Trench[®] MOSFET

60 V, 5.8 mΩ

Features

- Max $r_{DS(on)}$ = 5.8 m Ω at V_{GS} = 10 V, I_D = 15 A
- Max $r_{DS(on)}$ = 8.7 m Ω at V_{GS} = 4.5 V, I_D = 12 A
- Ideal for Flexible Layout in Primary Side of Bridge Topology
- 100% UIL Tested
- Kelvin High Side MOSFET Drive Pin-out Capability
- Termination is Lead-free and RoHS Compliant

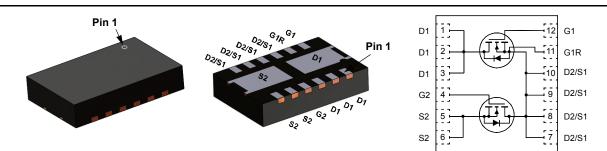


General Description

This device includes two 60V N-Channel MOSFETs in a dual Power (3.3 mm X 5 mm) package. HS source and LS Drain internally connected for half/full bridge, low source inductance package, low $r_{DS(on)}/Qg$ FOM silicon.

Applications

- Synchronous Buck : Primary Switch of Half / Full bridge Converter for Telecom
- Motor Bridge : Primary Switch of Half / Full bridge Converter for BLDC Motor
- MV POL : 48V Synchronous Buck Switch



Power 3.3 x 5

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted.

Symbol	Param	neter		Ratings	Units	
V _{DS}	Drain to Source Voltage			60	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C	(Note 5)	64		
	-Continuous	T _C = 100 °C	(Note 5)	40	•	
ID	-Continuous	T _A = 25 °C	(Note 1a)	15	Α	
	-Pulsed		(Note 4)	293		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	181	mJ	
-	Power Dissipation	T _C = 25 °C		37		
PD	Power Dissipation	T _A = 25 °C	(Note 1a)	2.1	W	
	Power Dissipation	T _A = 25 °C	(Note 1b)	1.0		
T _J , T _{STG}	Operating and Storage Junction Temper	ature Range		-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		3.4	
R_{\thetaJA}	Thermal Resistance, Junction to Ambient	(Note 1a)	60	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient	(Note 1b)	130	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
8260L	FDMD8260L	Power 3.3 x 5	13 "	12 mm	3000 units

1

FDMD8260L
Dual
N-Channel
PowerTrench [®]
MOSFET

-

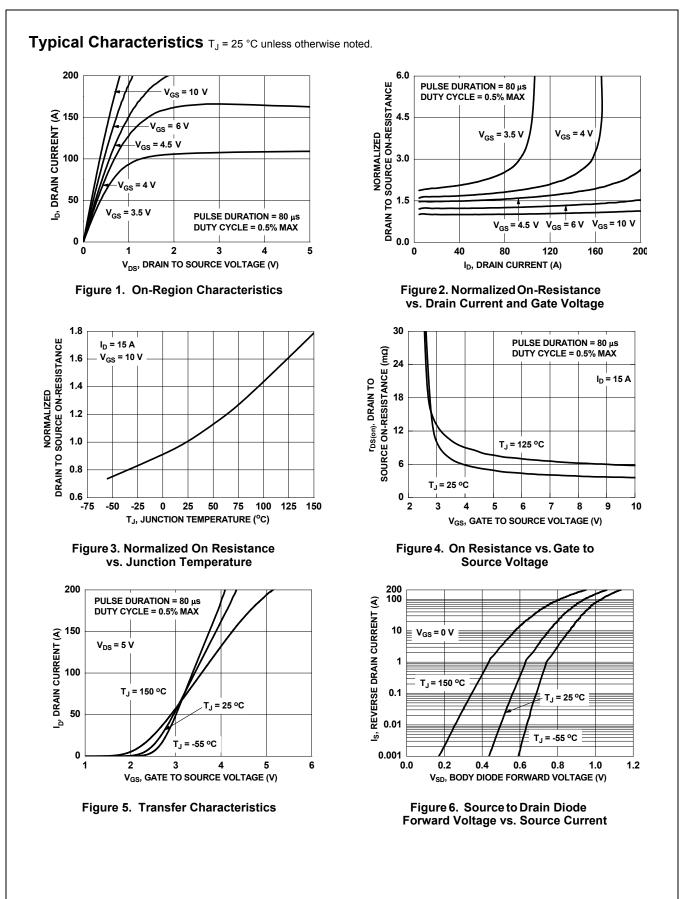
	Parameter	Test Conditions	Min.	Тур.	Max.	Units
	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	60			V
ΔBV_{DSS} ΔT_{J}	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		33		mV/°C
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 48 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 V, V_{DS} = 0 V$			±100	nA
On Chara	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	1.0	1.5	3.0	V
$\Delta V_{GS(th)}$ ΔT_J	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-6		mV/°C
r _{DS(on)}		V _{GS} = 10 V, I _D = 15 A		4.5	5.8	mΩ
	Static Drain to Source On Resistance	$V_{GS} = 4.5 V, I_D = 12 A$		6.6	8.7	
00(01)		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 15 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		5.9	7.8	
9 _{FS}	Forward Transconductance	$V_{DD} = 5 V, I_D = 15 A$		56		S
Jynamic	Characteristics					
C _{iss}	Input Capacitance			3745	5245	pF
C _{oss}	Output Capacitance	$-V_{DS} = 30 V, V_{GS} = 0 V$		558	785	pF
C _{rss}	Reverse Transfer Capacitance	f = 1 MHz		22	50	pF
R _g	Gate Resistance		0.1	3.0	6.0	Ω
*						
-	Turn-On Delay Time			10	21	
•				12	21	ns
	,			10	20	
t <mark>r</mark>	Rise Time	$V_{DD} = 30 \text{ V}, \text{ I}_{D} = 15 \text{ A}$		10	20	ns
t _r t _{d(off)}	Rise Time Turn-Off Delay Time	V_{DD} = 30 V, I _D = 15 A V _{GS} = 10 V, R _{GEN} = 6 Ω		47	74	ns
t _r t _{d(off)}	Rise Time Turn-Off Delay Time Fall Time	V_{GS} = 10 V, R_{GEN} = 6 Ω		47 11	74 20	ns ns
t _r t _{d(off)} t _f	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		47 11 49	74 20 68	ns ns nC
t <u>r</u> td(off) tf Q _{g(TOT)}	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 30 \text{ V}$		47 11 49 25	74 20	ns ns nC nC
t _r t _{d(off)} t _f Q _{g(TOT)} Q _{gs}	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		47 11 49 25 8.6	74 20 68	ns ns nC nC nC
t <mark>r t_{d(off)} t_f Q_{g(TOT)} Q_{gs}</mark>	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 30 \text{ V}$		47 11 49 25	74 20 68	ns ns nC nC
t _r t _{d(off)} t _f Q _{g(TOT)} Q _{gs} Q _{gd}	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 30 \text{ V}$ $I_{D} = 15 \text{ A}$		47 11 49 25 8.6	74 20 68	ns ns nC nC nC
t _r t _{d(off)} t Q _{g(TOT)} Q _{gs} Q _{gd} Drain-So t	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge Urce Diode Characteristics	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $I_D = 30 \text{ V}$ $I_D = 15 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 15 \text{ A}$ (Note 2)		47 11 49 25 8.6	74 20 68	ns ns nC nC nC
t _r t _{d(off)} t Q _{g(TOT)} Q _{gs} Q _{gd} Drain-So t	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge urce Diode Characteristics Source to Drain Diode Forward Voltage	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $V_{DD} = 30 \text{ V}$ $I_{D} = 15 \text{ A}$		47 11 49 25 8.6 5.2	74 20 68 35 1.3 1.2	ns ns nC nC nC nC
t _{d(on)} t <u>r</u> Q _{g(TOT)} Q _{gs} Q _{gd} Drain-Sou V _{SD} Q _{rr}	Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Total Gate Charge Gate to Source Charge Gate to Drain "Miller" Charge Urce Diode Characteristics	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$ $V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 5 \text{ V}$ $I_D = 30 \text{ V}$ $I_D = 15 \text{ A}$ $V_{GS} = 0 \text{ V}, \text{ I}_S = 15 \text{ A}$ (Note 2)		47 11 49 25 8.6 5.2 0.8	74 20 68 35 1.3	ns ns nC nC nC nC

ទ ក្ខ ខ្លួន ខ្លួន

Electrical Characteristics T_J = 25 °C unless otherwise noted.

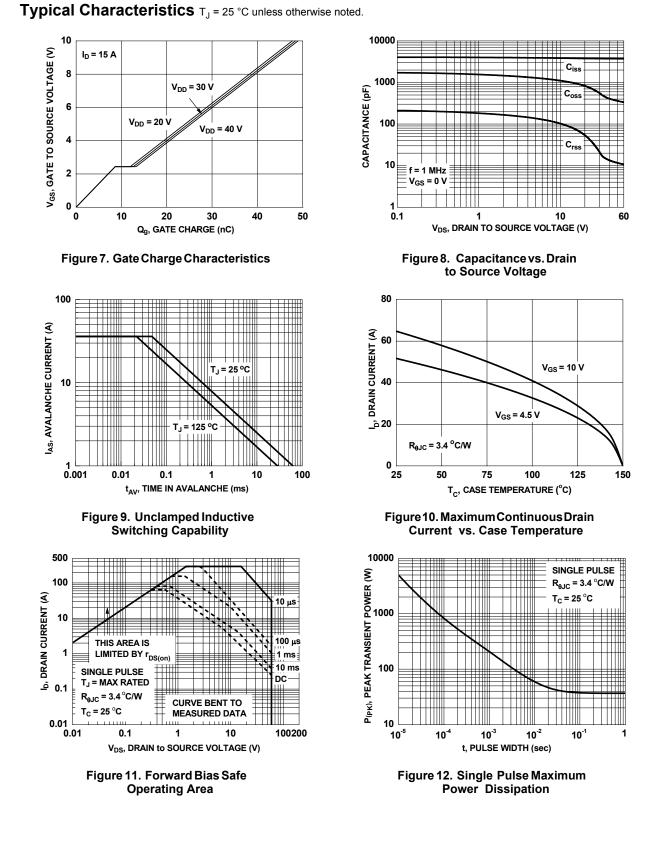
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0 %.

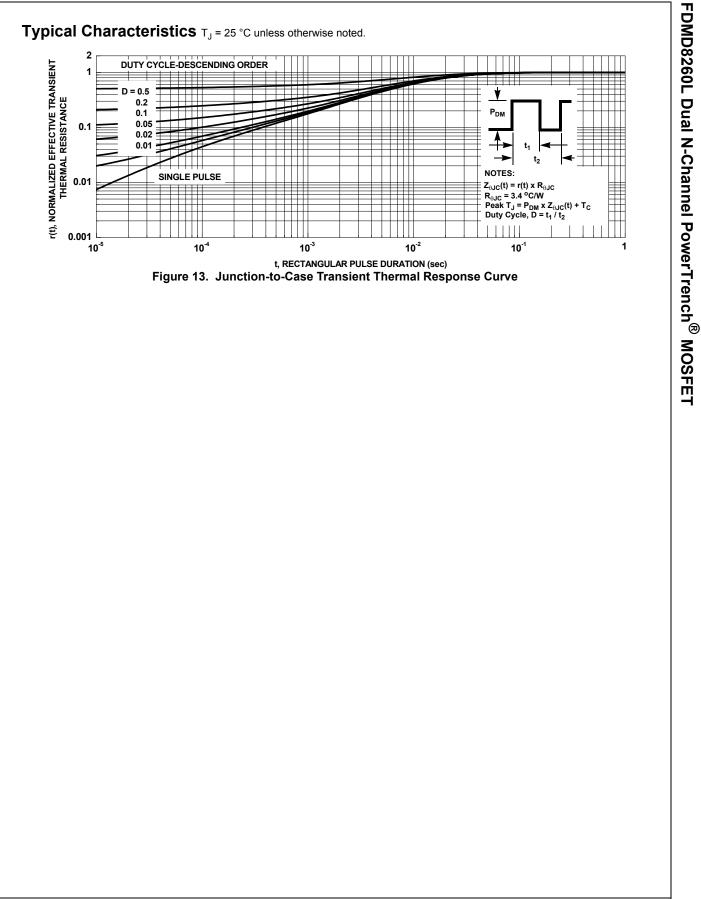
2. Pulse fest. Pulse when < 500 µs, puls goue < 2.0 m. 3. E_{AS} of 181 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 11 A, V_{DD} = 60 V, V_{GS} = 10 V. 100% tested at L = 0.1 mH, I_{AS} = 36 A. 4. Pulsed Id please refer to Fig 11 SOA graph for more details. 5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.



©2015 Fairchild Semiconductor Corporation FDMD8260L Rev.1.0







ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor haves against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death a

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC